

FEATURES

High common-mode transient immunity: 100 kV/μs

High robustness to radiated and conducted noise

Low propagation delay

13 ns maximum for 5 V operation

15 ns maximum for 1.8 V operation

150 Mbps maximum guaranteed data rate

Safety and regulatory approvals

UL recognition: 5000 V rms for 1 minute per UL 1577

CSA Component Acceptance Notice 5A

VDE certificate of conformity

DIN V VDE V 0884-11:2017-01

V_{IORM} = 849 V peak

CQC certification per GB4943.1-2011

Low dynamic power consumption

1.8 V to 5 V level translation

High temperature operation: 125°C

Fail-safe high or low options

16-lead, RoHS-compliant, wide body SOIC_IC package

APPLICATIONS

General-purpose multichannel isolation

Serial peripheral interface (SPI)/data converter isolation

Industrial field bus isolation

GENERAL DESCRIPTION

The ADuM260N/ADuM261N/ADuM262N/ADuM263N¹ are 6-channel digital isolators based on Analog Devices, Inc., iCoupler® technology. Combining high speed, complementary metal-oxide semiconductor (CMOS) and monolithic air core transformer technology, these isolation components provide outstanding performance characteristics superior to alternatives such as optocoupler devices and other integrated couplers. The maximum propagation delay is 13 ns with a pulse width distortion of less than 4.5 ns at 5 V operation. Channel to channel matching of propagation delay is tight at 4.0 ns maximum.

The ADuM260N/ADuM261N/ADuM262N/ADuM263N data channels are independent and are available in a variety of configurations with a withstand voltage rating of 5.0 kV rms (see the Ordering Guide). The devices operate with the supply voltage on either side ranging from 1.7 V to 5.5 V, providing compatibility with lower voltage systems as well as enabling voltage translation functionality across the isolation barrier.

Unlike other optocoupler alternatives, dc correctness is ensured in the absence of input logic transitions. Two different fail-safe options are available by which the outputs transition to a predetermined state when the input power supply is not applied.

¹ Protected by U.S. Patents 5,952,849; 6,873,065; 6,903,578; and 7,075,329. Other patents are pending.

Rev. B **Document Feedback**
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FUNCTIONAL BLOCK DIAGRAMS

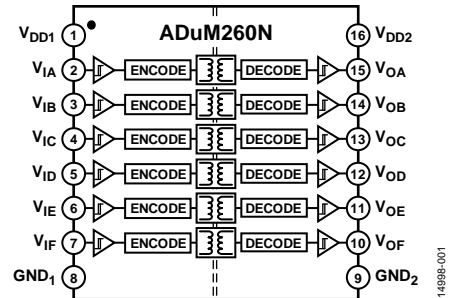


Figure 1. ADuM260N Functional Block Diagram

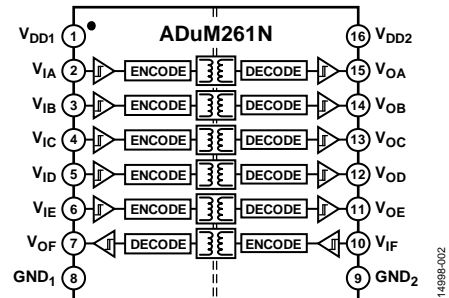


Figure 2. ADuM261N Functional Block Diagram

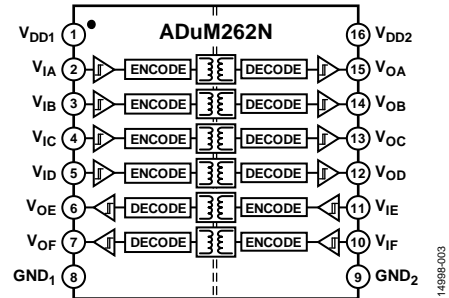


Figure 3. ADuM262N Functional Block Diagram

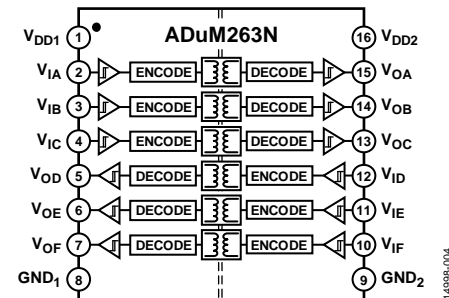


Figure 4. ADuM263N Functional Block Diagram

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REVISION HISTORY

10/2021—Rev. A to Rev. B

| | |
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| Updated Features..... | 1 |
| Changes to Table 11 | 11 |
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| Added Automotive Products Section | 24 |

7/2019—Rev. 0 to Rev. A

| | |
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| Changes to Table 11 | 11 |
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12/2016—Revision 0: Initial Version

SPECIFICATIONS

ELECTRICAL CHARACTERISTICS—5 V OPERATION

All typical specifications are at $T_A = 25^\circ\text{C}$, $V_{DD1} = V_{DD2} = 5\text{ V}$. Minimum/maximum specifications apply over the entire recommended operation range of $4.5\text{ V} \leq V_{DD1} \leq 5.5\text{ V}$, $4.5\text{ V} \leq V_{DD2} \leq 5.5\text{ V}$, and $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$, unless otherwise noted. Switching specifications are tested with $C_L = 15\text{ pF}$ and CMOS signal levels, unless otherwise noted. Supply currents are specified with 50% duty cycle signals.

Table 1.

| Parameter | Symbol | Min | Typ | Max | Unit | Test Conditions/Comments |
|---------------------------------|-----------------------|----------------------|-----------------|----------------------|---------------|--|
| SWITCHING SPECIFICATIONS | | | | | | |
| Pulse Width | PW | 6.6 | | | ns | Within pulse width distortion (PWD) limit |
| Data Rate ¹ | | 150 | | | Mbps | Within PWD limit |
| Propagation Delay | t_{PHL} , t_{PLH} | 4.8 | 7.2 | 13 | ns | 50% input to 50% output |
| Pulse Width Distortion | PWD | | 0.5 | 4.5 | ns | $ t_{PLH} - t_{PHL} $ |
| Change vs. Temperature | | | 1.5 | | ps/°C | |
| Propagation Delay Skew | t_{PSK} | | | 6.1 | ns | Between any two units at the same temperature, voltage, and load |
| Channel Matching | | | | | | |
| Codirectional | t_{PSKCD} | | 0.5 | 4.0 | ns | |
| Opposing Direction | t_{PSKOD} | | 0.5 | 4.5 | ns | |
| Jitter | | | 490 | | ps p-p | See the Jitter Measurement section |
| | | | 70 | | ps rms | See the Jitter Measurement section |
| DC SPECIFICATIONS | | | | | | |
| Input Threshold Voltage | | | | | | |
| Logic High | V_{IH} | $0.7 \times V_{DDx}$ | | | V | |
| Logic Low | V_{IL} | | | $0.3 \times V_{DDx}$ | V | |
| Output Voltage | | | | | | |
| Logic High | V_{OH} | $V_{DDx} - 0.1$ | V_{DDx} | | V | $I_{Ox}^2 = -20\text{ }\mu\text{A}$, $V_{Ix} = V_{IxH}^3$ |
| | | $V_{DDx} - 0.4$ | $V_{DDx} - 0.2$ | | V | $I_{Ox}^2 = -4\text{ mA}$, $V_{Ix} = V_{IxH}^3$ |
| Logic Low | V_{OL} | | 0.0 | 0.1 | V | $I_{Ox}^2 = 20\text{ }\mu\text{A}$, $V_{Ix} = V_{IxL}^4$ |
| | | | 0.2 | 0.4 | V | $I_{Ox}^2 = 4\text{ mA}$, $V_{Ix} = V_{IxL}^4$ |
| Input Current per Channel | I_i | -10 | +0.01 | +10 | μA | $0\text{ V} \leq V_{Ix} \leq V_{DDx}$ |
| Quiescent Supply Current | | | | | | |
| ADuM260N | | | | | | |
| | $I_{DD1(Q)}$ | | 2.3 | 3.5 | mA | $V_I^5 = 0\text{ (NO)}, 1\text{ (N1)}^6$ |
| | $I_{DD2(Q)}$ | | 3.3 | 4.52 | mA | $V_I^5 = 0\text{ (NO)}, 1\text{ (N1)}^6$ |
| | $I_{DD1(Q)}$ | | 19.3 | 30 | mA | $V_I^5 = 1\text{ (NO)}, 0\text{ (N1)}^6$ |
| | $I_{DD2(Q)}$ | | 3.5 | 4.82 | mA | $V_I^5 = 1\text{ (NO)}, 0\text{ (N1)}^6$ |
| ADuM261N | | | | | | |
| | $I_{DD1(Q)}$ | | 2.5 | 3.8 | mA | $V_I^5 = 0\text{ (NO)}, 1\text{ (N1)}^6$ |
| | $I_{DD2(Q)}$ | | 3.2 | 4.22 | mA | $V_I^5 = 0\text{ (NO)}, 1\text{ (N1)}^6$ |
| | $I_{DD1(Q)}$ | | 16.0 | 24.8 | mA | $V_I^5 = 1\text{ (NO)}, 0\text{ (N1)}^6$ |
| | $I_{DD2(Q)}$ | | 7.2 | 11.2 | mA | $V_I^5 = 1\text{ (NO)}, 0\text{ (N1)}^6$ |
| ADuM262N | | | | | | |
| | $I_{DD1(Q)}$ | | 2.8 | 4.0 | mA | $V_I^5 = 0\text{ (NO)}, 1\text{ (N1)}^6$ |
| | $I_{DD2(Q)}$ | | 3.0 | 4.2 | mA | $V_I^5 = 0\text{ (NO)}, 1\text{ (N1)}^6$ |
| | $I_{DD1(Q)}$ | | 14.1 | 22.5 | mA | $V_I^5 = 1\text{ (NO)}, 0\text{ (N1)}^6$ |
| | $I_{DD2(Q)}$ | | 10.5 | 16.7 | mA | $V_I^5 = 1\text{ (NO)}, 0\text{ (N1)}^6$ |
| ADuM263N | | | | | | |
| | $I_{DD1(Q)}$ | | 3.0 | 4.26 | mA | $V_I^5 = 0\text{ (NO)}, 1\text{ (N1)}^6$ |
| | $I_{DD2(Q)}$ | | 2.8 | 3.92 | mA | $V_I^5 = 0\text{ (NO)}, 1\text{ (N1)}^6$ |
| | $I_{DD1(Q)}$ | | 11.8 | 18.9 | mA | $V_I^5 = 1\text{ (NO)}, 0\text{ (N1)}^6$ |
| | $I_{DD2(Q)}$ | | 14.6 | 23 | mA | $V_I^5 = 1\text{ (NO)}, 0\text{ (N1)}^6$ |

| Parameter | Symbol | Min | Typ | Max | Unit | Test Conditions/Comments |
|---|--------------|-----|------|-----|-------------|---|
| Dynamic Supply Current | | | | | | |
| Dynamic Input | $I_{DDI(D)}$ | | 0.01 | | mA/Mbps | Inputs switching, 50% duty cycle |
| Dynamic Output | $I_{DDO(D)}$ | | 0.02 | | mA/Mbps | Inputs switching, 50% duty cycle |
| Undervoltage Lockout | UVLO | | | | | |
| Positive V_{DDx} Threshold | V_{DDxUV+} | | 1.6 | | V | |
| Negative V_{DDx} Threshold | V_{DDxUV-} | | 1.5 | | V | |
| V_{DDx} Hysteresis | V_{DDxUVH} | | 0.1 | | V | |
| AC SPECIFICATIONS | | | | | | |
| Output Rise/Fall Time | t_R/t_F | | 2.5 | | ns | 10% to 90% |
| Common-Mode Transient Immunity ⁷ | $ CM_H $ | 75 | 100 | | kV/ μ s | $V_{IX} = V_{DDx}$, $V_{CM} = 1000$ V, transient magnitude = 800 V |
| | $ CM_L $ | 75 | 100 | | kV/ μ s | $V_{IX} = 0$ V, $V_{CM} = 1000$ V, transient magnitude = 800 V |

¹ 150 Mbps is the highest data rate that can be guaranteed, although higher data rates are possible.

² I_{Dx} is the Channel x output current, where x = A, B, C, D, E, or F.

³ V_{IH} is the input side logic high.

⁴ V_{IL} is the input side logic low.

⁵ V_I is the voltage input.

⁶ N0 refers to the ADuM260N0/ADuM261N0/ADuM262N0/ADuM263N0 models. N1 refers to the ADuM260N1/ADuM261N1/ADuM262N1/ADuM263N1 models. See the Ordering Guide section.

⁷ $|CM_H|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining the voltage output (V_O) > 0.8 V_{DDx} . $|CM_L|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining V_O > 0.8 V. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

Table 2. Total Supply Current vs. Data Throughput

| Parameter | Symbol | 1 Mbps | | | 25 Mbps | | | 100 Mbps | | | Unit |
|-----------------------|-----------|--------|------|------|---------|------|------|----------|------|------|------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| SUPPLY CURRENT | | | | | | | | | | | |
| ADuM260N | | | | | | | | | | | |
| Supply Current Side 1 | I_{DD1} | | 10.8 | 15.8 | | 12.3 | 19.2 | | 18.3 | 26 | mA |
| Supply Current Side 2 | I_{DD2} | | 3.6 | 5.5 | | 5.63 | 9.0 | | 12.8 | 20.9 | mA |
| ADuM261N | | | | | | | | | | | |
| Supply Current Side 1 | I_{DD1} | | 9.27 | 14.5 | | 10.9 | 17.2 | | 17.3 | 25.6 | mA |
| Supply Current Side 2 | I_{DD2} | | 5.33 | 9.0 | | 7.39 | 12 | | 14.5 | 22.2 | mA |
| ADuM262N | | | | | | | | | | | |
| Supply Current Side 1 | I_{DD1} | | 8.53 | 13.0 | | 10.2 | 15.6 | | 16.4 | 25.5 | mA |
| Supply Current Side 2 | I_{DD2} | | 6.83 | 10.5 | | 8.64 | 13.1 | | 14.6 | 22.3 | mA |
| ADuM263N | | | | | | | | | | | |
| Supply Current Side 1 | I_{DD1} | | 7.47 | 12.3 | | 9.35 | 14.5 | | 15.9 | 23 | mA |
| Supply Current Side 2 | I_{DD2} | | 8.75 | 14.0 | | 10.5 | 16.0 | | 17.0 | 23.3 | mA |

ELECTRICAL CHARACTERISTICS—3.3 V OPERATION

All typical specifications are at $T_A = 25^\circ\text{C}$, $V_{DD1} = V_{DD2} = 3.3\text{ V}$. Minimum/maximum specifications apply over the entire recommended operation range: $3.0\text{ V} \leq V_{DD1} \leq 3.6\text{ V}$, $3.0\text{ V} \leq V_{DD2} \leq 3.6\text{ V}$, and $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$, unless otherwise noted. Switching specifications are tested with $C_L = 15\text{ pF}$ and CMOS signal levels, unless otherwise noted. Supply currents are specified with 50% duty cycle signals.

Table 3.

| Parameter | Symbol | Min | Typ | Max | Unit | Test Conditions/Comments |
|---------------------------------|-----------------------|----------------------|-----------------|----------------------|---------------|--|
| SWITCHING SPECIFICATIONS | | | | | | |
| Pulse Width | PW | 6.6 | | | ns | Within PWD limit |
| Data Rate ¹ | | 150 | | | Mbps | Within PWD limit |
| Propagation Delay | t_{PHL} , t_{PLH} | 4.8 | 6.8 | 14 | ns | 50% input to 50% output |
| Pulse Width Distortion | PWD | | 0.7 | 4.5 | ns | $ t_{PLH} - t_{PHL} $ |
| Change vs. Temperature | | | 1.5 | | ps/°C | |
| Propagation Delay Skew | t_{PSK} | | | 7.5 | ns | Between any two units at the same temperature, voltage, and load |
| Channel Matching | | | | | | |
| Codirectional | t_{PSKCD} | | 0.7 | 4.0 | ns | |
| Opposing Direction | t_{PSKOD} | | 0.7 | 4.5 | ns | |
| Jitter | | | 580 | | ps p-p | See the Jitter Measurement section |
| | | | 120 | | ps rms | See the Jitter Measurement section |
| DC SPECIFICATIONS | | | | | | |
| Input Threshold Voltage | | | | | | |
| Logic High | V_{IH} | $0.7 \times V_{DDx}$ | | | V | |
| Logic Low | V_{IL} | | | $0.3 \times V_{DDx}$ | V | |
| Output Voltage | | | | | | |
| Logic High | V_{OH} | $V_{DDx} - 0.1$ | V_{DDx} | | V | $I_{Ox}^2 = -20\text{ }\mu\text{A}$, $V_{Ix} = V_{IxH}^3$ |
| | | $V_{DDx} - 0.4$ | $V_{DDx} - 0.2$ | | V | $I_{Ox}^2 = -2\text{ mA}$, $V_{Ix} = V_{IxH}^3$ |
| Logic Low | V_{OL} | | 0.0 | 0.1 | V | $I_{Ox}^2 = 20\text{ }\mu\text{A}$, $V_{Ix} = V_{IxL}^4$ |
| | | | 0.2 | 0.4 | V | $I_{Ox}^2 = 2\text{ mA}$, $V_{Ix} = V_{IxL}^4$ |
| Input Current per Channel | I_i | -10 | +0.01 | +10 | μA | $0\text{ V} \leq V_{Ix} \leq V_{DDx}$ |
| Quiescent Supply Current | | | | | | |
| ADuM260N | | | | | | |
| | $I_{DD1(Q)}$ | | 2.2 | 3.4 | mA | $V_i^5 = 0$ (N0), 1 (N1) ⁶ |
| | $I_{DD2(Q)}$ | | 3.1 | 4.1 | mA | $V_i^5 = 0$ (N0), 1 (N1) ⁶ |
| | $I_{DD1(Q)}$ | | 19 | 27.7 | mA | $V_i^5 = 1$ (N0), 0 (N1) ⁶ |
| | $I_{DD2(Q)}$ | | 3.4 | 4.7 | mA | $V_i^5 = 1$ (N0), 0 (N1) ⁶ |
| ADuM261N | | | | | | |
| | $I_{DD1(Q)}$ | | 2.3 | 3.6 | mA | $V_i^5 = 0$ (N0), 1 (N1) ⁶ |
| | $I_{DD2(Q)}$ | | 3.0 | 4.0 | mA | $V_i^5 = 0$ (N0), 1 (N1) ⁶ |
| | $I_{DD1(Q)}$ | | 15.8 | 24.6 | mA | $V_i^5 = 1$ (N0), 0 (N1) ⁶ |
| | $I_{DD2(Q)}$ | | 7.0 | 11 | mA | $V_i^5 = 1$ (N0), 0 (N1) ⁶ |
| ADuM262N | | | | | | |
| | $I_{DD1(Q)}$ | | 2.6 | 3.8 | mA | $V_i^5 = 0$ (N0), 1 (N1) ⁶ |
| | $I_{DD2(Q)}$ | | 2.8 | 4.0 | mA | $V_i^5 = 0$ (N0), 1 (N1) ⁶ |
| | $I_{DD1(Q)}$ | | 13.9 | 22.2 | mA | $V_i^5 = 1$ (N0), 0 (N1) ⁶ |
| | $I_{DD2(Q)}$ | | 10.3 | 16.5 | mA | $V_i^5 = 1$ (N0), 0 (N1) ⁶ |
| ADuM263N | | | | | | |
| | $I_{DD1(Q)}$ | | 2.8 | 4.16 | mA | $V_i^5 = 0$ (N0), 1 (N1) ⁶ |
| | $I_{DD2(Q)}$ | | 2.6 | 3.82 | mA | $V_i^5 = 0$ (N0), 1 (N1) ⁶ |
| | $I_{DD1(Q)}$ | | 11.5 | 18.5 | mA | $V_i^5 = 1$ (N0), 0 (N1) ⁶ |
| | $I_{DD2(Q)}$ | | 14.3 | 22.5 | mA | $V_i^5 = 1$ (N0), 0 (N1) ⁶ |
| Dynamic Supply Current | | | | | | |
| Dynamic Input | $I_{DDI(D)}$ | | 0.01 | | mA/Mbps | Inputs switching, 50% duty cycle |
| Dynamic Output | $I_{DDO(D)}$ | | 0.01 | | mA/Mbps | Inputs switching, 50% duty cycle |

| Parameter | Symbol | Min | Typ | Max | Unit | Test Conditions/Comments |
|---|--------------------------------|-----|-----|-----|-------|---|
| Undervoltage Lockout | UVLO | | | | | |
| Positive V _{DDx} Threshold | V _{DDxUV+} | | 1.6 | | V | |
| Negative V _{DDx} Threshold | V _{DDxUV-} | | 1.5 | | V | |
| V _{DDx} Hysteresis | V _{DDxUVH} | | 0.1 | | V | |
| AC SPECIFICATIONS | | | | | | |
| Output Rise/Fall Time | t _r /t _f | | 2.5 | | ns | 10% to 90% |
| Common-Mode Transient Immunity ⁷ | CM _H | 75 | 100 | | kV/μs | V _{Ix} = V _{DDx} , V _{CM} = 1000 V, transient magnitude = 800 V |
| | CM _L | 75 | 100 | | kV/μs | V _{Ix} = 0 V, V _{CM} = 1000 V, transient magnitude = 800 V |

¹ 150 Mbps is the highest data rate that can be guaranteed, although higher data rates are possible.

² I_{ox} is the Channel x output current, where x = A, B, C, D, E, or F.

³ V_{IxH} is the input side logic high.

⁴ V_{IxL} is the input side logic low.

⁵ V_i is the voltage input.

⁶ N0 refers to the ADuM260N0/ADuM261N0/ADuM262N0/ADuM263N0 models. N1 refers to the ADuM260N1/ADuM261N1/ADuM262N1/ADuM263N1 models. See the Ordering Guide section.

⁷ |CM_H| is the maximum common-mode voltage slew rate that can be sustained while maintaining the voltage output (V_o) > 0.8 V_{DDx}. |CM_L| is the maximum common-mode voltage slew rate that can be sustained while maintaining V_o > 0.8 V. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

Table 4. Total Supply Current vs. Data Throughput

| Parameter | Symbol | 1 Mbps | | | 25 Mbps | | | 100 Mbps | | | Unit |
|-----------------------|------------------|--------|------|------|---------|------|------|----------|------|------|------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| SUPPLY CURRENT | | | | | | | | | | | |
| ADuM260N | | | | | | | | | | | |
| Supply Current Side 1 | I _{DD1} | | 10.5 | 15.5 | | 11.7 | 18.6 | | 16.6 | 24.6 | mA |
| Supply Current Side 2 | I _{DD2} | | 3.4 | 5.4 | | 5.4 | 7.8 | | 11.8 | 19.9 | mA |
| ADuM261N | | | | | | | | | | | |
| Supply Current Side 1 | I _{DD1} | | 9.0 | 14.2 | | 10.4 | 16.6 | | 15.7 | 24.1 | mA |
| Supply Current Side 2 | I _{DD2} | | 5.1 | 8.8 | | 7.0 | 11.6 | | 13.1 | 20.8 | mA |
| ADuM262N | | | | | | | | | | | |
| Supply Current Side 1 | I _{DD1} | | 8.3 | 12.8 | | 9.8 | 14.8 | | 15.2 | 24.3 | mA |
| Supply Current Side 2 | I _{DD2} | | 6.6 | 10.3 | | 8.3 | 12.6 | | 13.8 | 21.5 | mA |
| ADuM263N | | | | | | | | | | | |
| Supply Current Side 1 | I _{DD1} | | 7.3 | 12 | | 8.9 | 14.2 | | 14.9 | 22 | mA |
| Supply Current Side 2 | I _{DD2} | | 8.5 | 13.7 | | 9.9 | 15.6 | | 16 | 22.3 | mA |

ELECTRICAL CHARACTERISTICS—2.5 V OPERATION

All typical specifications are at $T_A = 25^\circ\text{C}$, $V_{DD1} = V_{DD2} = 2.5\text{ V}$. Minimum/maximum specifications apply over the entire recommended operation range: $2.25\text{ V} \leq V_{DD1} \leq 2.75\text{ V}$, $2.25\text{ V} \leq V_{DD2} \leq 2.75\text{ V}$, $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$, unless otherwise noted. Switching specifications are tested with $C_L = 15\text{ pF}$ and CMOS signal levels, unless otherwise noted. Supply currents are specified with 50% duty cycle signals.

Table 5.

| Parameter | Symbol | Min | Typ | Max | Unit | Test Conditions/Comments |
|---------------------------------|-----------------------|----------------------|-----------------|----------------------|----------------------|--|
| SWITCHING SPECIFICATIONS | | | | | | |
| Pulse Width | PW | 6.6 | | | ns | Within PWD limit |
| Data Rate ¹ | | 150 | | | Mbps | Within PWD limit |
| Propagation Delay | t_{PHL} , t_{PLH} | 5.0 | 7.0 | 14 | ns | 50% input to 50% output |
| Pulse Width Distortion | PWD | | 0.7 | 5.0 | ns | $ t_{PLH} - t_{PHL} $ |
| Change vs. Temperature | | | 1.5 | | ps/ $^\circ\text{C}$ | |
| Propagation Delay Skew | t_{PSK} | | | 6.8 | ns | Between any two units at the same temperature, voltage, load |
| Channel Matching | | | | | | |
| Codirectional | t_{PSKCD} | | 0.7 | 5.0 | ns | |
| Opposing Direction | t_{PSKOD} | | 0.7 | 5.0 | ns | |
| Jitter | | | 800 | | ps p-p | See the Jitter Measurement section |
| | | | 190 | | ps rms | See the Jitter Measurement section |
| DC SPECIFICATIONS | | | | | | |
| Input Threshold Voltage | | | | | | |
| Logic High | V_{IH} | $0.7 \times V_{DDx}$ | | | V | |
| Logic Low | V_{IL} | | | $0.3 \times V_{DDx}$ | V | |
| Output Voltage | | | | | | |
| Logic High | V_{OH} | $V_{DDx} - 0.1$ | V_{DDx} | | V | $I_{Ox}^2 = -20\ \mu\text{A}$, $V_{Ix} = V_{IxH}^3$ |
| | | $V_{DDx} - 0.4$ | $V_{DDx} - 0.2$ | | V | $I_{Ox}^2 = -2\ \text{mA}$, $V_{Ix} = V_{IxH}^3$ |
| Logic Low | V_{OL} | | 0.0 | 0.1 | V | $I_{Ox}^2 = 20\ \mu\text{A}$, $V_{Ix} = V_{IxL}^4$ |
| | | | 0.2 | 0.4 | V | $I_{Ox}^2 = 2\ \text{mA}$, $V_{Ix} = V_{IxL}^4$ |
| Input Current per Channel | I_I | -10 | +0.01 | +10 | μA | $0\text{ V} \leq V_{Ix} \leq V_{DDx}$ |
| Quiescent Supply Current | | | | | | |
| ADuM260N | | | | | | |
| | $I_{DD1(Q)}$ | | 2.1 | 3.3 | mA | $V_I^5 = 0\ (N0), 1\ (N1)^6$ |
| | $I_{DD2(Q)}$ | | 3.1 | 4.1 | mA | $V_I^5 = 0\ (N0), 1\ (N1)^6$ |
| | $I_{DD1(Q)}$ | | 19 | 27.7 | mA | $V_I^5 = 1\ (N0), 0\ (N1)^6$ |
| | $I_{DD2(Q)}$ | | 3.3 | 4.6 | mA | $V_I^5 = 1\ (N0), 0\ (N1)^6$ |
| ADuM261N | | | | | | |
| | $I_{DD1(Q)}$ | | 2.2 | 3.5 | mA | $V_I^5 = 0\ (N0), 1\ (N1)^6$ |
| | $I_{DD2(Q)}$ | | 2.9 | 3.9 | mA | $V_I^5 = 0\ (N0), 1\ (N1)^6$ |
| | $I_{DD1(Q)}$ | | 15.7 | 24.5 | mA | $V_I^5 = 1\ (N0), 0\ (N1)^6$ |
| | $I_{DD2(Q)}$ | | 6.9 | 10.9 | mA | $V_I^5 = 1\ (N0), 0\ (N1)^6$ |
| ADuM262N | | | | | | |
| | $I_{DD1(Q)}$ | | 2.5 | 3.7 | mA | $V_I^5 = 0\ (N0), 1\ (N1)^6$ |
| | $I_{DD2(Q)}$ | | 2.7 | 3.9 | mA | $V_I^5 = 0\ (N0), 1\ (N1)^6$ |
| | $I_{DD1(Q)}$ | | 13.8 | 22.1 | mA | $V_I^5 = 1\ (N0), 0\ (N1)^6$ |
| | $I_{DD2(Q)}$ | | 10.2 | 16.4 | mA | $V_I^5 = 1\ (N0), 0\ (N1)^6$ |
| ADuM263N | | | | | | |
| | $I_{DD1(Q)}$ | | 2.7 | 4.08 | mA | $V_I^5 = 0\ (N0), 1\ (N1)^6$ |
| | $I_{DD2(Q)}$ | | 2.55 | 3.72 | mA | $V_I^5 = 0\ (N0), 1\ (N1)^6$ |
| | $I_{DD1(Q)}$ | | 11.5 | 18.4 | mA | $V_I^5 = 1\ (N0), 0\ (N1)^6$ |
| | $I_{DD2(Q)}$ | | 14.3 | 22.3 | mA | $V_I^5 = 1\ (N0), 0\ (N1)^6$ |
| Dynamic Supply Current | | | | | | |
| Dynamic Input | $I_{DDI(D)}$ | | 0.01 | | mA/Mbps | Inputs switching, 50% duty cycle |
| Dynamic Output | $I_{DDO(D)}$ | | 0.01 | | mA/Mbps | Inputs switching, 50% duty cycle |

| Parameter | Symbol | Min | Typ | Max | Unit | Test Conditions/Comments |
|---|--------------|-----|-----|-----|-------------|--|
| Undervoltage Lockout | | | | | | |
| Positive V_{DDx} Threshold | V_{DDxUV+} | | 1.6 | | V | |
| Negative V_{DDx} Threshold | V_{DDxUV-} | | 1.5 | | V | |
| V_{DDx} Hysteresis | V_{DDxUVH} | | 0.1 | | V | |
| AC SPECIFICATIONS | | | | | | |
| Output Rise/Fall Time | t_R/t_F | | 2.5 | | ns | 10% to 90% |
| Common-Mode Transient Immunity ⁷ | $ CM_H $ | 75 | 100 | | kV/ μ s | $V_{IX} = V_{DDx}$, $V_{CM} = 1000$ V, transient magnitude = 800 V |
| | $ CM_L $ | 75 | 100 | | kV/ μ s | $V_{IX} = 0$ V, $V_{CM} = 1000$ V, transient magnitude = 800 V |

¹ 150 Mbps is the highest data rate that can be guaranteed, although higher data rates are possible.

² I_{Ox} is the Channel x output current, where x = A, B, C, D, E, or F.

³ V_{IH} is the input side logic high.

⁴ V_{IL} is the input side logic low.

⁵ V_I is the voltage input.

⁶ N0 refers to the ADuM260N0/ADuM261N0/ADuM262N0/ADuM263N0 models. N1 refers to the ADuM260N1/ADuM261N1/ADuM262N1/ADuM263N1 models. See the Ordering Guide section.

⁷ $|CM_H|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining the voltage output (V_O) > 0.8 V_{DDx} . $|CM_L|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining V_O > 0.8 V. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

Table 6. Total Supply Current vs. Data Throughput

| Parameter | Symbol | 1 Mbps | | | 25 Mbps | | | 100 Mbps | | | Unit |
|-----------------------|-----------|--------|------|------|---------|------|------|----------|------|------|------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| SUPPLY CURRENT | | | | | | | | | | | |
| ADuM260N | | | | | | | | | | | |
| Supply Current Side 1 | I_{DD1} | | 10.4 | 15.4 | | 11.2 | 18.4 | | 16 | 24 | mA |
| Supply Current Side 2 | I_{DD2} | | 3.3 | 5.3 | | 4.8 | 7.2 | | 9.8 | 17.9 | mA |
| ADuM261N | | | | | | | | | | | |
| Supply Current Side 1 | I_{DD1} | | 8.9 | 14.1 | | 10.1 | 16.3 | | 14.8 | 23.6 | mA |
| Supply Current Side 2 | I_{DD2} | | 5.0 | 8.7 | | 6.5 | 11.1 | | 11.4 | 20.1 | mA |
| ADuM262N | | | | | | | | | | | |
| Supply Current Side 1 | I_{DD1} | | 8.1 | 12.6 | | 9.4 | 14.4 | | 14.1 | 23.2 | mA |
| Supply Current Side 2 | I_{DD2} | | 6.5 | 10.2 | | 7.8 | 12.1 | | 12.4 | 20.1 | mA |
| ADuM263N | | | | | | | | | | | |
| Supply Current Side 1 | I_{DD1} | | 7.1 | 11.9 | | 8.5 | 13.9 | | 13.6 | 21 | mA |
| Supply Current Side 2 | I_{DD2} | | 8.3 | 13.4 | | 9.7 | 15.2 | | 14.8 | 21.3 | mA |

ELECTRICAL CHARACTERISTICS—1.8 V OPERATION

All typical specifications are at $T_A = 25^\circ\text{C}$, $V_{DD1} = V_{DD2} = 1.8\text{ V}$. Minimum/maximum specifications apply over the entire recommended operation range: $1.7\text{ V} \leq V_{DD1} \leq 1.9\text{ V}$, $1.7\text{ V} \leq V_{DD2} \leq 1.9\text{ V}$, and $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$, unless otherwise noted. Switching specifications are tested with $C_L = 15\text{ pF}$ and CMOS signal levels, unless otherwise noted. Supply currents are specified with 50% duty cycle signals.

Table 7.

| Parameter | Symbol | Min | Typ | Max | Unit | Test Conditions/Comments |
|---------------------------------|-----------------------|----------------------|-----------------|----------------------|---------------|--|
| SWITCHING SPECIFICATIONS | | | | | | |
| Pulse Width | PW | 6.6 | | | ns | Within PWD limit |
| Data Rate ¹ | | 150 | | | Mbps | Within PWD limit |
| Propagation Delay | t_{PHL} , t_{PLH} | 5.8 | 8.7 | 15 | ns | 50% input to 50% output |
| Pulse Width Distortion | PWD | | 0.7 | 5.0 | ns | $ t_{PLH} - t_{PHL} $ |
| Change vs. Temperature | | | 1.5 | | ps/°C | |
| Propagation Delay Skew | t_{PSK} | | | 7.0 | ns | Between any two units at the same temperature, voltage, and load |
| Channel Matching | | | | | | |
| Codirectional | t_{PSKCD} | | 0.7 | 5.0 | ns | |
| Opposing Direction | t_{PSKOD} | | 0.7 | 5.0 | ns | |
| Jitter | | | 470 | | ps p-p | See the Jitter Measurement section |
| | | | 70 | | ps rms | See the Jitter Measurement section |
| DC SPECIFICATIONS | | | | | | |
| Input Threshold Voltage | | | | | | |
| Logic High | V_{IH} | $0.7 \times V_{DDx}$ | | | V | |
| Logic Low | V_{IL} | | | $0.3 \times V_{DDx}$ | V | |
| Output Voltage | | | | | | |
| Logic High | V_{OH} | $V_{DDx} - 0.1$ | V_{DDx} | | V | $I_{Ox}^2 = -20\ \mu\text{A}$, $V_{Ix} = V_{IxH}^3$ |
| | | $V_{DDx} - 0.4$ | $V_{DDx} - 0.2$ | | V | $I_{Ox}^2 = -2\ \text{mA}$, $V_{Ix} = V_{IxH}^3$ |
| Logic Low | V_{OL} | | 0.0 | 0.1 | V | $I_{Ox}^2 = 20\ \mu\text{A}$, $V_{Ix} = V_{IxL}^4$ |
| | | | 0.2 | 0.4 | V | $I_{Ox}^2 = 2\ \text{mA}$, $V_{Ix} = V_{IxL}^4$ |
| Input Current per Channel | I_i | -10 | +0.01 | +10 | μA | $0\text{ V} \leq V_{Ix} \leq V_{DDx}$ |
| Quiescent Supply Current | | | | | | |
| ADuM260N | | | | | | |
| | $I_{DD1(Q)}$ | | 2.0 | 3.2 | mA | $V_I^5 = 0\text{ (NO)}, 1\text{ (N1)}^6$ |
| | $I_{DD2(Q)}$ | | 3.0 | 4.0 | mA | $V_I^5 = 0\text{ (NO)}, 1\text{ (N1)}^6$ |
| | $I_{DD1(Q)}$ | | 18.7 | 27.4 | mA | $V_I^5 = 1\text{ (NO)}, 0\text{ (N1)}^6$ |
| | $I_{DD2(Q)}$ | | 3.3 | 4.6 | mA | $V_I^5 = 1\text{ (NO)}, 0\text{ (N1)}^6$ |
| ADuM261N | | | | | | |
| | $I_{DD1(Q)}$ | | 2.1 | 3.4 | mA | $V_I^5 = 0\text{ (NO)}, 1\text{ (N1)}^6$ |
| | $I_{DD2(Q)}$ | | 2.9 | 3.9 | mA | $V_I^5 = 0\text{ (NO)}, 1\text{ (N1)}^6$ |
| | $I_{DD1(Q)}$ | | 15.5 | 24.3 | mA | $V_I^5 = 1\text{ (NO)}, 0\text{ (N1)}^6$ |
| | $I_{DD2(Q)}$ | | 6.8 | 10.8 | mA | $V_I^5 = 1\text{ (NO)}, 0\text{ (N1)}^6$ |
| ADuM262N | | | | | | |
| | $I_{DD1(Q)}$ | | 2.4 | 3.6 | mA | $V_I^5 = 0\text{ (NO)}, 1\text{ (N1)}^6$ |
| | $I_{DD2(Q)}$ | | 2.7 | 3.9 | mA | $V_I^5 = 0\text{ (NO)}, 1\text{ (N1)}^6$ |
| | $I_{DD1(Q)}$ | | 13.7 | 22 | mA | $V_I^5 = 1\text{ (NO)}, 0\text{ (N1)}^6$ |
| | $I_{DD2(Q)}$ | | 10.1 | 16.3 | mA | $V_I^5 = 1\text{ (NO)}, 0\text{ (N1)}^6$ |
| ADuM263N | | | | | | |
| | $I_{DD1(Q)}$ | | 2.6 | 4.03 | mA | $V_I^5 = 0\text{ (NO)}, 1\text{ (N1)}^6$ |
| | $I_{DD2(Q)}$ | | 2.5 | 3.72 | mA | $V_I^5 = 0\text{ (NO)}, 1\text{ (N1)}^6$ |
| | $I_{DD1(Q)}$ | | 11.3 | 18.3 | mA | $V_I^5 = 1\text{ (NO)}, 0\text{ (N1)}^6$ |
| | $I_{DD2(Q)}$ | | 14 | 22 | mA | $V_I^5 = 1\text{ (NO)}, 0\text{ (N1)}^6$ |
| Dynamic Supply Current | | | | | | |
| Dynamic Input | $I_{DDI(D)}$ | | 0.01 | | mA/Mbps | Inputs switching, 50% duty cycle |
| Dynamic Output | $I_{DDO(D)}$ | | 0.01 | | mA/Mbps | Inputs switching, 50% duty cycle |

| Parameter | Symbol | Min | Typ | Max | Unit | Test Conditions/Comments |
|---|--------------------------------|-----|-----|-----|-------|---|
| Undervoltage Lockout | UVLO | | | | | |
| Positive V _{DDx} Threshold | V _{DDxUV+} | | 1.6 | | V | |
| Negative V _{DDx} Threshold | V _{DDxUV-} | | 1.5 | | V | |
| V _{DDx} Hysteresis | V _{DDxUVH} | | 0.1 | | V | |
| AC SPECIFICATIONS | | | | | | |
| Output Rise/Fall Time | t _R /t _F | | 2.5 | | ns | 10% to 90% |
| Common-Mode Transient Immunity ⁷ | CM _H | 75 | 100 | | kV/μs | V _{Ix} = V _{DDx} , V _{CM} = 1000 V, transient magnitude = 800 V |
| | CM _L | 75 | 100 | | kV/μs | V _{Ix} = 0 V, V _{CM} = 1000 V, transient magnitude = 800 V |

¹ 150 Mbps is the highest data rate that can be guaranteed, although higher data rates are possible.

² I_{ox} is the Channel x output current, where x = A, B, C, D, E, or F.

³ V_{IxH} is the input side logic high.

⁴ V_{IxL} is the input side logic low.

⁵ V_i is the voltage input.

⁶ N0 refers to the ADuM260N0/ADuM261N0/ADuM262N0/ADuM263N0 models. N1 refers to the ADuM260N1/ADuM261N1/ADuM262N1/ADuM263N1 models. See the Ordering Guide section.

⁷ |CM_H| is the maximum common-mode voltage slew rate that can be sustained while maintaining the voltage output (V_o) > 0.8 V_{DDx}. |CM_L| is the maximum common-mode voltage slew rate that can be sustained while maintaining V_o > 0.8 V. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

Table 8. Total Supply Current vs. Data Throughput

| Parameter | Symbol | 1 Mbps | | | 25 Mbps | | | 100 Mbps | | | Unit |
|-----------------------|------------------|--------|------|------|---------|------|------|----------|------|------|------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| SUPPLY CURRENT | | | | | | | | | | | |
| ADuM260N | | | | | | | | | | | |
| Supply Current Side 1 | I _{DD1} | | 10.2 | 15.2 | | 11.3 | 18.2 | | 15.9 | 23.9 | mA |
| Supply Current Side 2 | I _{DD2} | | 3.3 | 5.3 | | 4.8 | 7.2 | | 9.8 | 17.9 | mA |
| ADuM261N | | | | | | | | | | | |
| Supply Current Side 1 | I _{DD1} | | 8.7 | 13.9 | | 10 | 16.2 | | 14.6 | 23.4 | mA |
| Supply Current Side 2 | I _{DD2} | | 4.9 | 8.6 | | 6.4 | 11 | | 11.4 | 20.1 | mA |
| ADuM262N | | | | | | | | | | | |
| Supply Current Side 1 | I _{DD1} | | 8.0 | 12.5 | | 9.2 | 14.2 | | 13.9 | 23 | mA |
| Supply Current Side 2 | I _{DD2} | | 6.4 | 10.1 | | 7.7 | 12 | | 12.4 | 20.1 | mA |
| ADuM263N | | | | | | | | | | | |
| Supply Current Side 1 | I _{DD1} | | 7.0 | 11.8 | | 8.3 | 13.7 | | 13.3 | 20.7 | mA |
| Supply Current Side 2 | I _{DD2} | | 8.2 | 13.3 | | 9.5 | 15 | | 14.5 | 21 | mA |

INSULATION AND SAFETY RELATED SPECIFICATIONS

For additional information, see www.analog.com/icouplersafety.

Table 9.

| Parameter | Symbol | Value | Unit | Test Conditions/Comments |
|---|---------|-------|--------|--|
| Rated Dielectric Insulation Voltage | | 5000 | V rms | 1-minute duration |
| Minimum External Air Gap (Clearance) | L (I01) | 8.3 | mm min | Measured from input terminals to output terminals, shortest distance through air |
| Minimum External Tracking (Creepage) | L (I02) | 8.3 | mm min | Measured from input terminals to output terminals, shortest distance path along body |
| Minimum Clearance in the Plane of the Printed Circuit Board (PCB Clearance) | L (PCB) | 8.3 | mm min | Measured from input terminals to output terminals, shortest distance through air, line of sight, in the PCB mounting plane |
| Minimum Internal Gap (Internal Clearance) | | 25.5 | µm min | Minimum distance through insulation |
| Tracking Resistance (Comparative Tracking Index) | CTI | >400 | V | DIN IEC 112/VDE 0303 Part 1 |
| Material Group | | II | | Material Group (DIN VDE 0110, 1/89, Table 1) |

PACKAGE CHARACTERISTICS**Table 10.**

| Parameter | Symbol | Min | Typ | Max | Unit | Test Conditions/Comments |
|--|------------------|-----|------------------|-----|------|---|
| Resistance (Input to Output) ¹ | R _{I-O} | | 10 ¹³ | | Ω | |
| Capacitance (Input to Output) ¹ | C _{I-O} | | 2.2 | | pF | f = 1 MHz |
| Input Capacitance ² | C _I | | 4.0 | | pF | |
| IC Junction to Ambient Thermal Resistance | θ _{JA} | | 45 | | °C/W | Thermocouple located at center of package underside |

¹ The device is considered a 2-terminal device: Pin 1 through Pin 8 are shorted together, and Pin 9 through Pin 16 are shorted together.

² Input capacitance is from any input data pin to ground.

REGULATORY INFORMATION

See Table 15 and the Insulation Lifetime section for details regarding recommended maximum working voltages for specific cross-isolation waveforms and insulation levels.

Table 11.

| UL | CSA | VDE | CQC |
|---|--|--|---|
| Recognized Under UL 1577 Component Recognition Program ¹ | Approved under CSA Component Acceptance Notice 5A | Certified according to DIN V VDE V 0884-11:2017-01 ² | Certified under CQC11-471543-2015, GB4943.1-2011: |
| Single Protection, 5000 V rms Isolation Voltage | CSA 60950-1-07+A1+A2, CSA 62368-1-14, IEC 60950-1 2nd Ed.+A1+A2 and IEC 62368-1 2nd Ed. Basic insulation at 870 V rms Reinforced insulation at 435 V rms IEC 60601-1 Edition 3 + A1 2 MOPP for 276Vrms CSA 61010-1-12+A1 and IEC 61010-1 3rd edition: Basic insulation at 300 V rms mains, 830 V rms secondary | Reinforced insulation, V _{IORM} = 849 V peak, V _{IOSM} = 6250 V peak | Basic insulation at 830 V rms (1174 V peak) Reinforced insulation at 415 V rms (587 V peak) Tropical climate, altitude ≤5000 meters |
| File E214100 | File 205078 | File 2471900-4880-0003 | File CQC18001192420 |

¹ In accordance with UL 1577, each ADuM260N/ADuM261N/ADuM262N/ADuM263N in the RI-16 wide body (SOIC_IC) package is proof tested by applying an insulation test voltage ≥ 6000 V rms for 1 sec.

² In accordance with DIN V VDE V 0884-11, each ADuM260N/ADuM261N/ADuM262N/ADuM263N in the RI-16 wide body (SOIC_IC) package is proof tested by applying an insulation test voltage ≥ 1592 V peak for 1 sec (partial discharge detection limit = 5 pC). The * marking branded on the component designates DIN V VDE V 0884-11 approval.

DIN V VDE V 0884-11 (VDE V 0884-11) INSULATION CHARACTERISTICS

These isolators are suitable for reinforced electrical isolation only within the safety limit data. Protective circuits ensure the maintenance of the safety data. The * marking on packages denotes DIN V VDE V 0884-11 approval.

Table 12.

| Description | Test Conditions/Comments | Symbol | Characteristic | Unit |
|---|--|-------------|--------------------------------|--------|
| Installation Classification per DIN VDE 0110 For Rated Mains Voltage ≤ 150 V rms For Rated Mains Voltage ≤ 300 V rms For Rated Mains Voltage ≤ 600 V rms | | | I to IV I to IV I to III | |
| Climatic Classification | | | 40/125/21 | |
| Pollution Degree per DIN VDE 0110, Table 1 | | | 2 | |
| Maximum Working Insulation Voltage | | V_{IORM} | 849 | V peak |
| Input to Output Test Voltage, Method B1 | $V_{IORM} \times 1.875 = V_{pd(m)}$, 100% production test, $t_{ini} = t_m = 1$ sec, partial discharge < 5 pC | $V_{pd(m)}$ | 1592 | V peak |
| Input to Output Test Voltage, Method A After Environmental Tests Subgroup 1 | $V_{IORM} \times 1.5 = V_{pd(m)}$, $t_{ini} = 60$ sec, $t_m = 10$ sec, partial discharge < 5 pC | $V_{pd(m)}$ | 1274 | V peak |
| After Input and/or Safety Test Subgroup 2 and Subgroup 3 | $V_{IORM} \times 1.2 = V_{pd(m)}$, $t_{ini} = 60$ sec, $t_m = 10$ sec, partial discharge < 5 pC | | 1019 | V peak |
| Highest Allowable Overvoltage | | V_{IOTM} | 8000 | V peak |
| Surge Isolation Voltage Reinforced | | V_{IOSM} | 6250 | V peak |
| Safety Limiting Values | Maximum value allowed in the event of a failure (see Figure 5) | | | |
| Maximum Junction Temperature | | T_S | 150 | °C |
| Total Power Dissipation at 25°C | | P_S | 2.78 | W |
| Insulation Resistance at T_S | | R_S | >10 ⁹ | Ω |

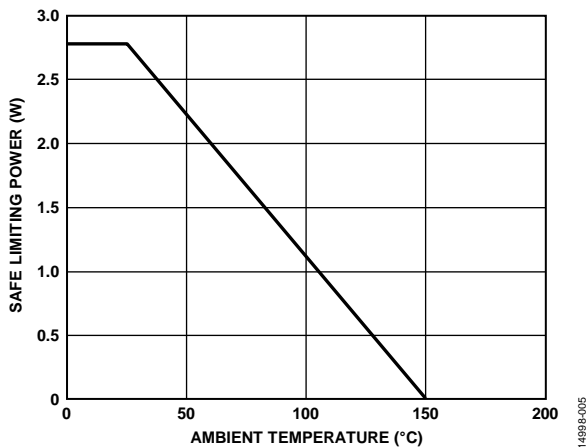


Figure 5. Thermal Derating Curve, Dependence of Safety Limiting Values with Ambient Temperature per DIN V VDE V 0884-11

RECOMMENDED OPERATING CONDITIONS

Table 13.

| Parameter | Symbol | Rating |
|----------------------------------|--------------------|-----------------|
| Operating Temperature | T_A | -40°C to +125°C |
| Supply Voltages | V_{DD1}, V_{DD2} | 1.7 V to 5.5 V |
| Input Signal Rise and Fall Times | | 1.0 ms |

ABSOLUTE MAXIMUM RATINGS

T_A = 25°C, unless otherwise noted.

Table 14.

| Parameter | Rating |
|--|---|
| Storage Temperature (T _{ST}) Range | –65°C to +150°C |
| Ambient Operating Temperature (T _A) Range | –40°C to +125°C |
| Supply Voltages (V _{DD1} , V _{DD2}) | –0.5 V to +7.0 V |
| Input Voltages (V _{IA} , V _{IB} , V _{IC} , V _{ID} , V _{IE} , V _{IF}) | –0.5 V to V _{DD1} ¹ + 0.5 V |
| Output Voltages (V _{OA} , V _{OB} , V _{OC} , V _{OD} , V _{OE} , V _{OF}) | –0.5 V to V _{DDO} ² + 0.5 V |
| Average Output Current per Pin ³ | |
| Side 1 Output Current (I _{O1}) | –10 mA to +10 mA |
| Side 2 Output Current (I _{O2}) | –10 mA to +10 mA |
| Common-Mode Transients ⁴ | –150 kV/μs to +150 kV/μs |

¹ V_{DD1} is the input side supply voltage.

² V_{DDO} is the output side supply voltage.

³ See Figure 5 for the maximum rated current values for various temperatures.

⁴ Refers to the common-mode transients across the insulation barrier.

Common-mode transients exceeding the absolute maximum ratings may cause latch-up or permanent damage.

Table 15. Maximum Continuous Working Voltage¹

| Parameter | Rating | Constraint |
|-----------------------|-------------|---|
| AC Voltage | | |
| Bipolar Waveform | | |
| Basic Insulation | 849 V peak | 50-year minimum insulation lifetime |
| Reinforced Insulation | 819 V peak | Lifetime limited by package creepage maximum approved working voltage per IEC 60950-1 |
| Unipolar Waveform | | |
| Basic Insulation | 1698 V peak | 50-year minimum insulation lifetime |
| Reinforced Insulation | 943 V peak | Lifetime limited by package creepage maximum approved working voltage per IEC 60950-1 |
| DC Voltage | | |
| Basic Insulation | 1157 V peak | Lifetime limited by package creepage maximum approved working voltage per IEC 60950-1 |
| Reinforced Insulation | 579 V peak | Lifetime limited by package creepage maximum approved working voltage per IEC 60950-1 |

¹ Refers to the continuous voltage magnitude imposed across the isolation barrier. See the Insulation Lifetime section for more details.

Truth Table

Table 16. ADuM260N/ADuM261N/ADuM262N/ADuM263N Truth Table (Positive Logic)

| V _{ix} Input ^{1, 2} | V _{DD1} State ² | V _{DDO} State ² | Default Low (N0), V _{Ox} Output ^{1, 2, 3} | Default High (N1), V _{Ox} Output ^{1, 2, 3} | Test Conditions/Comments |
|---------------------------------------|-------------------------------------|-------------------------------------|---|--|--------------------------|
| L | Powered | Powered | L | L | Normal operation |
| H | Powered | Powered | H | H | Normal operation |
| L | Unpowered | Powered | L | H | Fail-safe output |
| X ⁴ | Powered | Unpowered | Indeterminate | Indeterminate | Output Unpowered |

¹ L means low, H means high, and X means don't care.

² V_{ix} and V_{Ox} refer to the input and output signals of a given channel (A, B, C, D, E or F). V_{DD1} and V_{DDO} refer to the supply voltages on the input and output sides of the given channel, respectively.

³ N0 refers to the ADuM260N0/ADuM261N0/ADuM262N0/ADuM263N0 models. N1 refers to the ADuM260N1/ADuM261N1/ADuM262N1/ADuM263N1 models. See the Ordering Guide section.

⁴ Input pins (V_{ix}) on the same side as an unpowered supply must be in a low state to avoid powering the device through its ESD protection circuitry.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

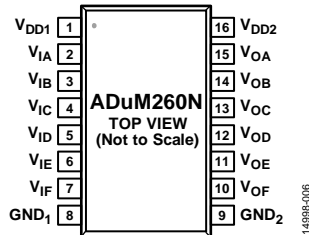


Figure 6. ADuM260N Pin Configuration

Table 17. ADuM260N Pin Function Descriptions

| Pin No. ¹ | Mnemonic | Description |
|----------------------|------------------|---|
| 1 | V _{DD1} | Supply Voltage for Isolator Side 1. |
| 2 | V _{IA} | Logic Input A. |
| 3 | V _{IB} | Logic Input B. |
| 4 | V _{IC} | Logic Input C. |
| 5 | V _{ID} | Logic Input D. |
| 6 | V _{IE} | Logic Input E. |
| 7 | V _{IF} | Logic Input F. |
| 8 | GND ₁ | Ground 1. Ground reference for Isolator Side 1. |
| 9 | GND ₂ | Ground 2. Ground reference for Isolator Side 2. |
| 10 | V _{OF} | Logic Output F. |
| 11 | V _{OE} | Logic Output E. |
| 12 | V _{OD} | Logic Output D. |
| 13 | V _{OC} | Logic Output C. |
| 14 | V _{OB} | Logic Output B. |
| 15 | V _{OA} | Logic Output A. |
| 16 | V _{DD2} | Supply Voltage for Isolator Side 2. |

¹ Reference the [AN-1109 Application Note](#) for specific layout guidelines.

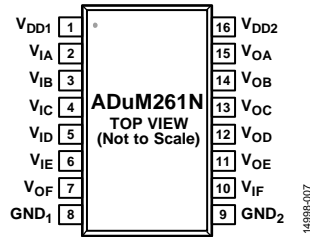


Figure 7. ADuM261N Pin Configuration

Table 18. ADuM261N Pin Function Descriptions

| Pin No. ¹ | Mnemonic | Description |
|----------------------|------------------|---|
| 1 | V _{DD1} | Supply Voltage for Isolator Side 1. |
| 2 | V _{IA} | Logic Input A. |
| 3 | V _{IB} | Logic Input B. |
| 4 | V _{IC} | Logic Input C. |
| 5 | V _{ID} | Logic Input D. |
| 6 | V _{IE} | Logic Input E. |
| 7 | V _{OF} | Logic Output F. |
| 8 | GND ₁ | Ground 1. Ground reference for Isolator Side 1. |
| 9 | GND ₂ | Ground 2. Ground reference for Isolator Side 2. |
| 10 | V _{IF} | Logic Input F. |
| 11 | V _{OE} | Logic Output E. |
| 12 | V _{OD} | Logic Output D. |
| 13 | V _{OC} | Logic Output C. |
| 14 | V _{OB} | Logic Output B. |
| 15 | V _{OA} | Logic Output A. |
| 16 | V _{DD2} | Supply Voltage for Isolator Side 2. |

¹ Reference the [AN-1109 Application Note](#) for specific layout guidelines.

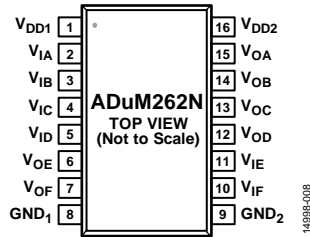


Figure 8. ADuM262N Pin Configuration

Table 19. ADuM262N Pin Function Descriptions

| Pin No. ¹ | Mnemonic | Description |
|----------------------|------------------|---|
| 1 | V _{DD1} | Supply Voltage for Isolator Side 1. |
| 2 | V _{IA} | Logic Input A. |
| 3 | V _{IB} | Logic Input B. |
| 4 | V _{IC} | Logic Input C. |
| 5 | V _{ID} | Logic Input D. |
| 6 | V _{OE} | Logic Output E. |
| 7 | V _{OF} | Logic Output F. |
| 8 | GND ₁ | Ground 1. Ground reference for Isolator Side 1. |
| 9 | GND ₂ | Ground 2. Ground reference for Isolator Side 2. |
| 10 | V _{IF} | Logic Input F. |
| 11 | V _{IE} | Logic Input E. |
| 12 | V _{OD} | Logic Output D. |
| 13 | V _{OC} | Logic Output C. |
| 14 | V _{OB} | Logic Output B. |
| 15 | V _{OA} | Logic Output A. |
| 16 | V _{DD2} | Supply Voltage for Isolator Side 2. |

¹ Reference the [AN-1109 Application Note](#) for specific layout guidelines.

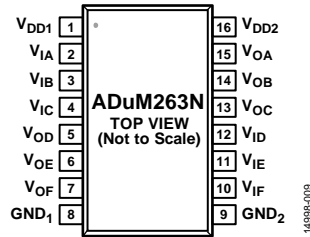


Figure 9. ADuM263N Pin Configuration

Table 20. ADuM263N Pin Function Descriptions

| Pin No. ¹ | Mnemonic | Description |
|----------------------|------------------|---|
| 1 | V _{DD1} | Supply Voltage for Isolator Side 1. |
| 2 | V _{IA} | Logic Input A. |
| 3 | V _{IB} | Logic Input B. |
| 4 | V _{IC} | Logic Input C. |
| 5 | V _{OD} | Logic Output D. |
| 6 | V _{OE} | Logic Output E. |
| 7 | V _{OF} | Logic Output F. |
| 8 | GND ₁ | Ground 1. Ground reference for Isolator Side 1. |
| 9 | GND ₂ | Ground 2. Ground reference for Isolator Side 2. |
| 10 | V _{IF} | Logic Input F. |
| 11 | V _{IE} | Logic Input E. |
| 12 | V _{ID} | Logic Input D. |
| 13 | V _{OC} | Logic Output C. |
| 14 | V _{OB} | Logic Output B. |
| 15 | V _{OA} | Logic Output A. |
| 16 | V _{DD2} | Supply Voltage for Isolator Side 2. |

¹ Reference the [AN-1109 Application Note](#) for specific layout guidelines.

TYPICAL PERFORMANCE CHARACTERISTICS

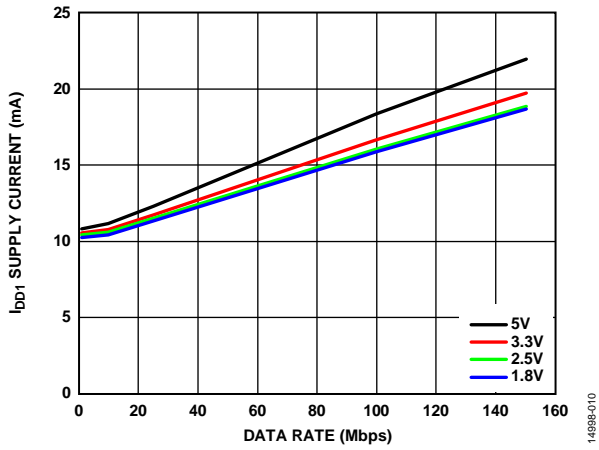


Figure 10. ADuM260N I_{DD1} Supply Current vs. Data Rate at Various Voltages

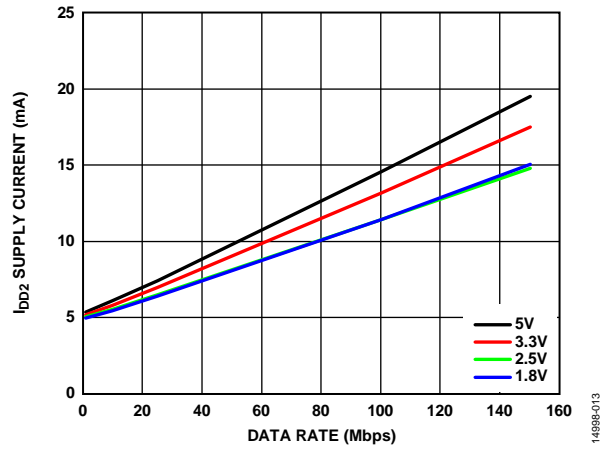


Figure 13. ADuM261N I_{DD2} Supply Current vs. Data Rate at Various Voltages

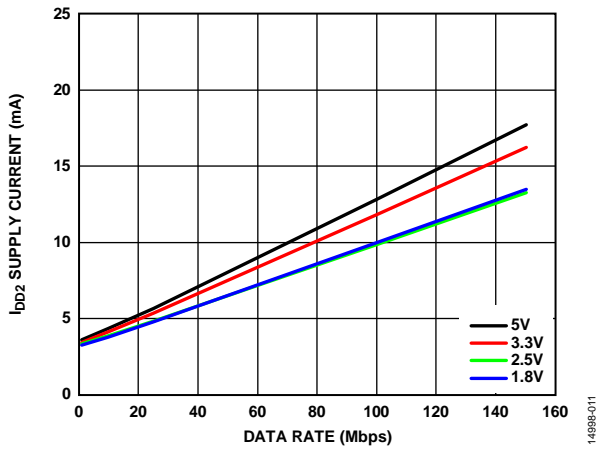


Figure 11. ADuM260N I_{DD2} Supply Current vs. Data Rate at Various Voltages

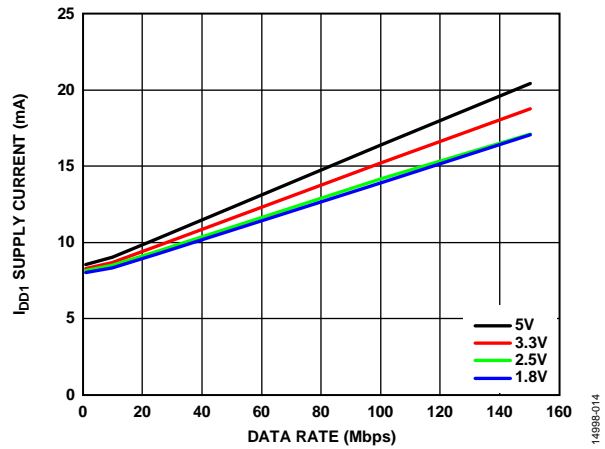


Figure 14. ADuM262N I_{DD1} Supply Current vs. Data Rate at Various Voltages

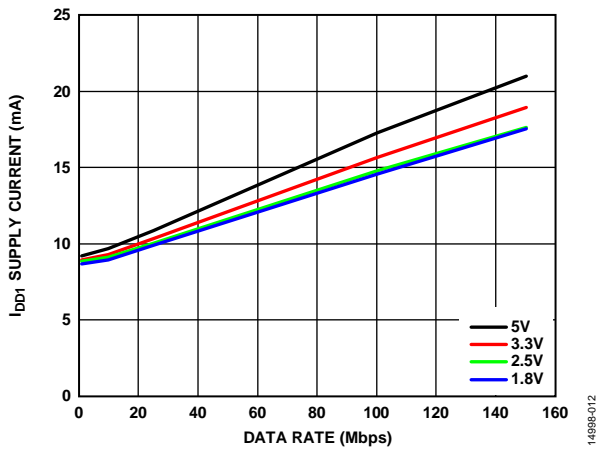


Figure 12. ADuM261N I_{DD1} Supply Current vs. Data Rate at Various Voltages

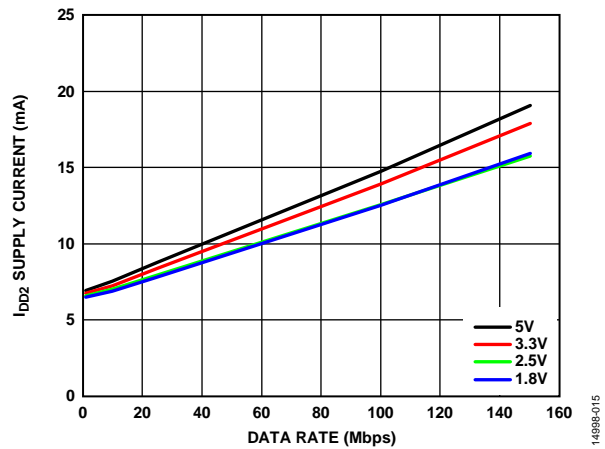


Figure 15. ADuM262N I_{DD2} Supply Current vs. Data Rate at Various Voltages

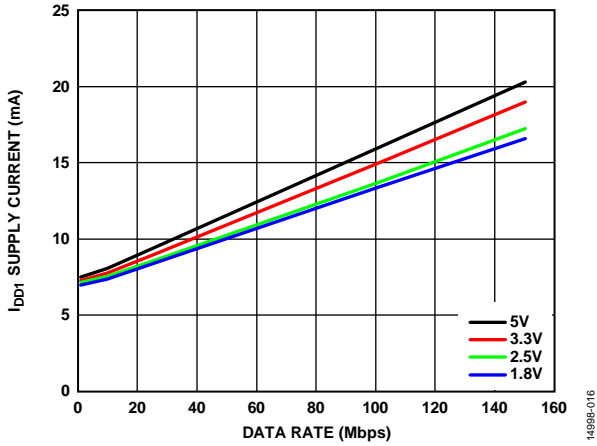


Figure 16. ADuM263N I_{DD1} Supply Current vs. Data Rate at Various Voltages

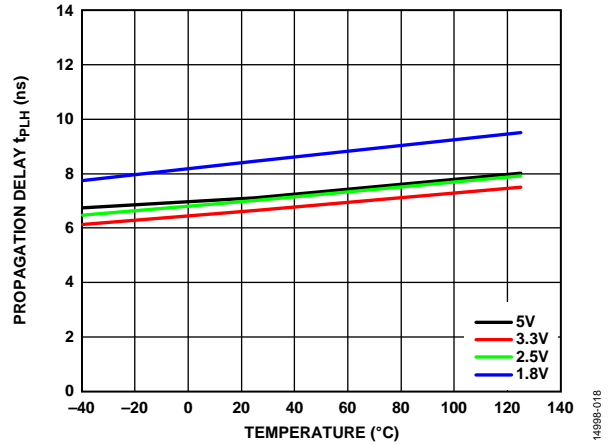


Figure 18. Propagation Delay, t_{PLH} vs. Temperature at Various Voltages

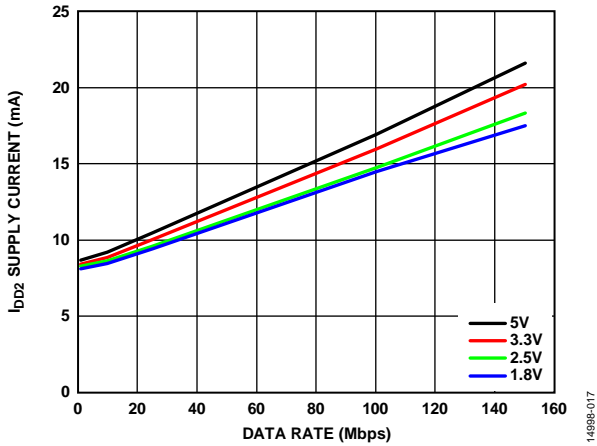


Figure 17. ADuM263N I_{DD2} Supply Current vs. Data Rate at Various Voltages

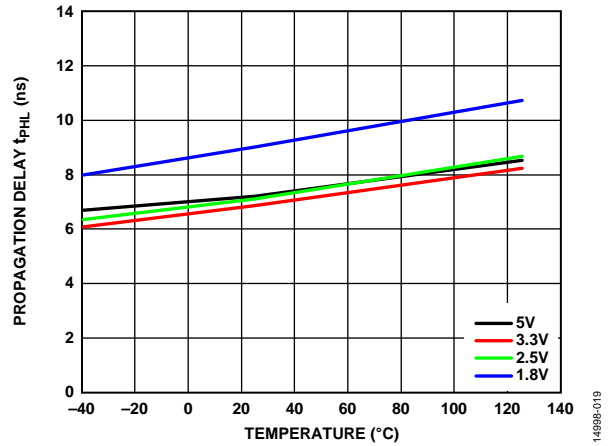


Figure 19. Propagation Delay, t_{PHL} vs. Temperature at Various Voltages

THEORY OF OPERATION

The ADuM260N/ADuM261N/ADuM262N/ADuM263N use a high frequency carrier to transmit data across the isolation barrier using *i*Coupler chip scale transformer coils separated by layers of polyimide isolation. Using an on/off keying (OOK) technique and the differential architecture shown in Figure 20 and Figure 21, the ADuM260N/ADuM261N/ADuM262N/ADuM263N have very low propagation delay and high speed. Internal regulators and input/output design techniques allow logic and supply voltages over a wide range from 1.7 V to 5.5 V, offering voltage translation of 1.8 V, 2.5 V, 3.3 V, and 5 V logic. The architecture is designed for high common-mode transient immunity and high immunity to electrical noise and magnetic interference. Radiated emissions are minimized with a spread spectrum OOK carrier and other techniques.

Figure 20 shows the waveforms for models of the ADuM260N0/ADuM261N0/ADuM262N0/ADuM263N0 that have the condition of the fail-safe output state equal to low, where the carrier waveform is off when the input state is low. If the input side is off or not operating, the fail-safe output state of low sets the output to low. For the ADuM260N1/ADuM261N1/ADuM262N1/ADuM263N1 that have a fail-safe output state of high, Figure 21 illustrates the conditions where the carrier waveform is off when the input state is high. When the input side is off or not operating, the fail-safe output state of high sets the output to high. See the Ordering Guide for the model numbers that have the fail-safe output state of low or the fail-safe output state of high.

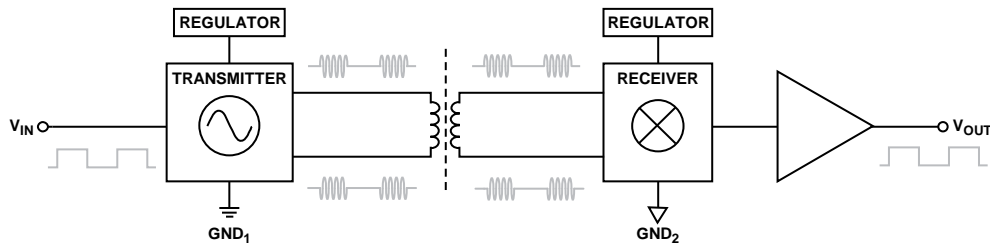


Figure 20. Operational Block Diagram of a Single Channel with a Low Fail-Safe Output State

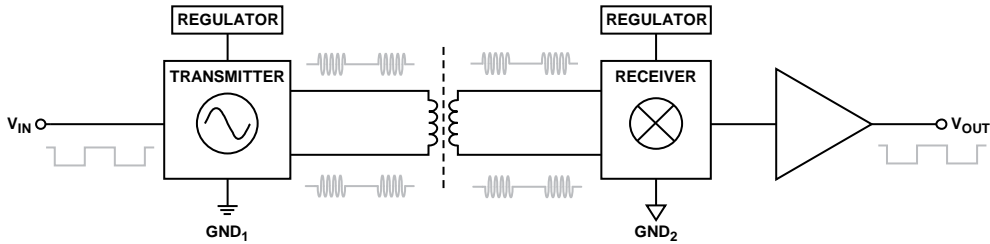


Figure 21. Operational Block Diagram of a Single Channel with a High Fail-Safe Output State

APPLICATIONS INFORMATION

PCB LAYOUT

The ADuM260N/ADuM261N/ADuM262N/ADuM263N digital isolators require no external interface circuitry for the logic interfaces. Power supply bypassing is strongly recommended at the input and output supply pins (see Figure 22). Bypass capacitors are connected between Pin 1 and Pin 8 for V_{DD1} and between Pin 9 and Pin 16 for V_{DD2} . The recommended bypass capacitor value is between 0.01 μF and 0.1 μF . The total lead length between both ends of the capacitor and the input power supply pin must not exceed 10 mm.

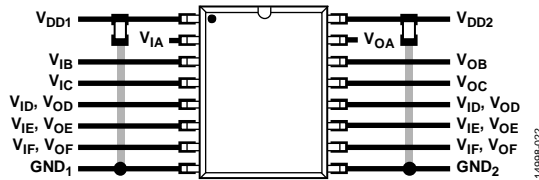


Figure 22. Recommended Printed Circuit Board Layout

In applications involving high common-mode transients, ensure that board coupling across the isolation barrier is minimized. Furthermore, design the board layout such that any coupling that does occur equally affects all pins on a given component side. Failure to ensure this can cause voltage differentials between pins exceeding the Absolute Maximum Ratings of the device, thereby leading to latch-up or permanent damage.

See the AN-1109 Application Note for board layout guidelines.

PROPAGATION DELAY RELATED PARAMETERS

Propagation delay is a parameter that describes the time it takes a logic signal to propagate through a component. The propagation delay to a Logic 0 output may differ from the propagation delay to a Logic 1 output.

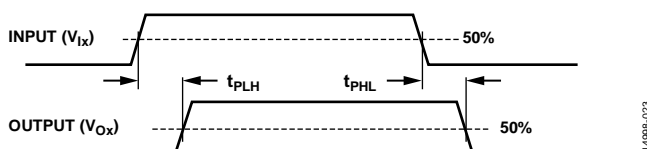


Figure 23. Propagation Delay Parameters

Pulse width distortion is the maximum difference between these two propagation delay values and is an indication of how accurately the timing of the input signal is preserved.

Channel matching is the maximum amount the propagation delay differs between channels within a single ADuM260N/ADuM261N/ADuM262N/ADuM263N component.

Propagation delay skew is the maximum amount the propagation delay differs between multiple ADuM260N/ADuM261N/ADuM262N/ADuM263N components operating under the same conditions.

JITTER MEASUREMENT

Figure 24 illustrates the eye diagram for the ADuM260N/ADuM261N/ADuM262N/ADuM263N. The measurement was

taken using an Agilent 81110A pulse pattern generator at 150 Mbps with pseudorandom bit sequences (PRBS) $2(n-1)$, $n=14$, for 5 V supplies. Jitter was measured with the Tektronix Model 5104B oscilloscope, 1 GHz, 10 GSPS with the DPOJET jitter and eye diagram analysis tools. The result shows a typical measurement on the ADuM260N/ADuM261N/ADuM262N/ADuM263N with 490 ps p-p jitter.

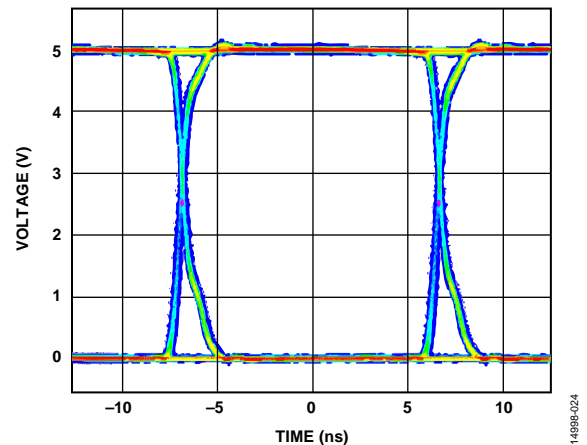


Figure 24. ADuM260N/ADuM261N/ADuM262N/ADuM263N Eye Diagram

INSULATION LIFETIME

All insulation structures eventually break down when subjected to voltage stress over a sufficiently long period. The rate of insulation degradation is dependent on the characteristics of the voltage waveform applied across the insulation as well as on the materials and material interfaces.

The two types of insulation degradation of primary interest are breakdown along surfaces exposed to the air and insulation wear out. Surface breakdown is the phenomenon of surface tracking, and the primary determinant of surface creepage requirements in system level standards. Insulation wear out is the phenomenon where charge injection or displacement currents inside the insulation material cause long-term insulation degradation.

Surface Tracking

Surface tracking is addressed in electrical safety standards by setting a minimum surface creepage based on the working voltage, the environmental conditions, and the properties of the insulation material. Safety agencies perform characterization testing on the surface insulation of components that allows the components to be categorized in different material groups. Lower material group ratings are more resistant to surface tracking and, therefore, can provide adequate lifetime with smaller creepage. The minimum creepage for a given working voltage and material group is in each system level standard and is based on the total rms voltage across the isolation, pollution degree, and material group. The material group and creepage for the ADuM260N/ADuM261N/ADuM262N/ADuM263N isolators are presented in Table 9.

Insulation Wear Out

The lifetime of insulation caused by wear out is determined by its thickness, material properties, and the voltage stress applied. It is important to verify that the product lifetime is adequate at the application working voltage. The working voltage supported by an isolator for wear out may not be the same as the working voltage supported for tracking. The working voltage applicable to tracking is specified in most standards.

Testing and modeling have shown that the primary driver of long-term degradation is displacement current in the polyimide insulation causing incremental damage. The stress on the insulation can be broken down into broad categories, such as: dc stress, which causes very little wear out because there is no displacement current, and an ac component time varying voltage stress, which causes wear out.

The ratings in certification documents are usually based on 60 Hz sinusoidal stress because this reflects isolation from line voltages. However, many practical applications have combinations of 60 Hz ac and dc across the barrier as shown in Equation 1. Because only the ac portion of the stress causes wear out, Equation 1 can be rearranged to solve for the ac rms voltage, as is shown in Equation 2. For insulation wear out with the polyimide materials used in these products, the ac rms voltage determines the product lifetime.

$$V_{RMS} = \sqrt{V_{AC\ RMS}^2 + V_{DC}^2} \quad (1)$$

or

$$V_{AC\ RMS} = \sqrt{V_{RMS}^2 - V_{DC}^2} \quad (2)$$

where:

$V_{AC\ RMS}$ is the time varying portion of the working voltage.

V_{RMS} is the total rms working voltage.

V_{DC} is the dc offset of the working voltage.

Calculation and Use of Parameters Example

The following example frequently arises in power conversion applications. Assume that the line voltage on one side of the isolation is 240 V ac rms, a 400 V dc bus voltage is present on the other side of the isolation barrier, and the isolator material is polyimide. To establish the critical voltages in determining the creepage, clearance and lifetime of a device, see Figure 25 and the following equations.

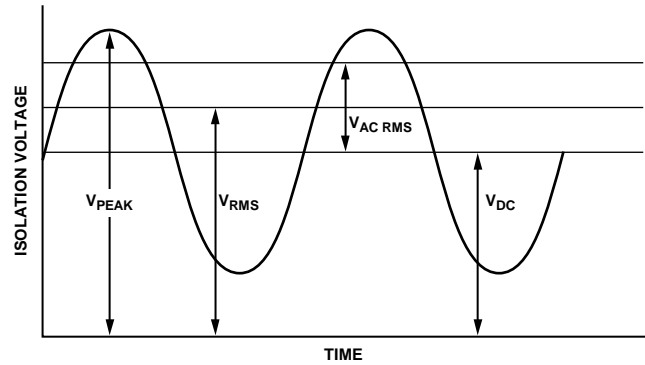


Figure 25. Critical Voltage Example

The working voltage across the barrier from Equation 1 is

$$V_{RMS} = \sqrt{V_{AC\ RMS}^2 + V_{DC}^2}$$

$$V_{RMS} = \sqrt{240^2 + 400^2}$$

$$V_{RMS} = 466\text{ V}$$

This V_{RMS} value is the working voltage used together with the material group and pollution degree when looking up the creepage required by a system standard.

To determine if the lifetime is adequate, obtain the time varying portion of the working voltage. To obtain the ac rms voltage, use Equation 2.

$$V_{AC\ RMS} = \sqrt{V_{RMS}^2 - V_{DC}^2}$$

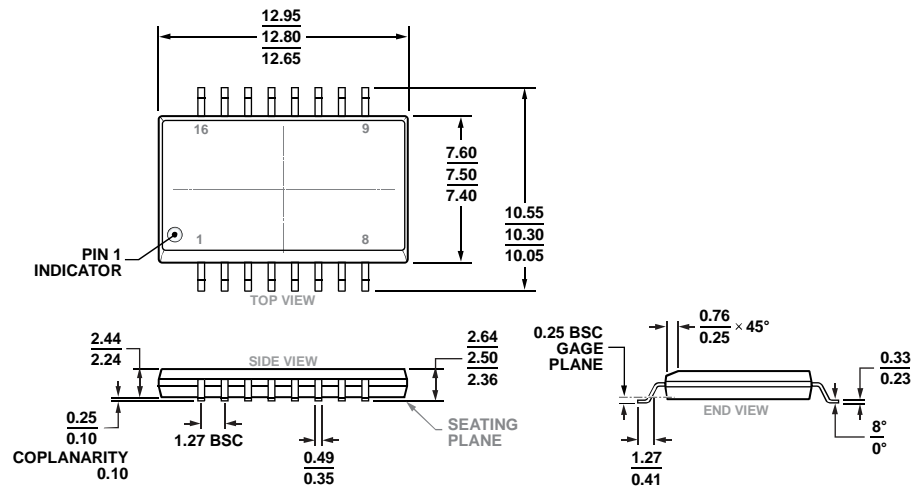
$$V_{AC\ RMS} = \sqrt{466^2 - 400^2}$$

$$V_{AC\ RMS} = 240\text{ V rms}$$

In this case, the ac rms voltage is simply the line voltage of 240 V rms. This calculation is more relevant when the waveform is not sinusoidal. The value is compared to the limits for working voltage in Table 15 for the expected lifetime, less than a 60 Hz sine wave, and it is well within the limit for a 50-year service life.

Note that the dc working voltage limit in Table 15 is set by the creepage of the package as specified in IEC 60664-1. This value can differ for specific system level standards.

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MS-013-AC

Figure 26. 16-Lead Standard Small Outline Package, with Increased Creepage [SOIC_IC] Wide Body (RI-16-2)
Dimensions shown in millimeters

ORDERING GUIDE

| Model ^{1, 2} | Temperature Range | No. of Inputs, V _{DD1} Side | No. of Inputs, V _{DD2} Side | Withstand Voltage Rating (kV rms) | Fail-Safe Output State | Package Description | Package Option |
|-----------------------|-------------------|--------------------------------------|--------------------------------------|-----------------------------------|------------------------|---------------------|----------------|
| ADuM260N1BRIZ | -40°C to +125°C | 6 | 0 | 5.0 | High | 16-Lead SOIC_IC | RI-16-2 |
| ADuM260N1BRIZ-RL | -40°C to +125°C | 6 | 0 | 5.0 | High | 16-Lead SOIC_IC | RI-16-2 |
| ADuM260N0BRIZ | -40°C to +125°C | 6 | 0 | 5.0 | Low | 16-Lead SOIC_IC | RI-16-2 |
| ADuM260N0BRIZ-RL | -40°C to +125°C | 6 | 0 | 5.0 | Low | 16-Lead SOIC_IC | RI-16-2 |
| ADuM261N1BRIZ | -40°C to +125°C | 5 | 1 | 5.0 | High | 16-Lead SOIC_IC | RI-16-2 |
| ADuM261N1BRIZ-RL | -40°C to +125°C | 5 | 1 | 5.0 | High | 16-Lead SOIC_IC | RI-16-2 |
| ADuM261N0BRIZ | -40°C to +125°C | 5 | 1 | 5.0 | Low | 16-Lead SOIC_IC | RI-16-2 |
| ADuM261N0BRIZ-RL | -40°C to +125°C | 5 | 1 | 5.0 | Low | 16-Lead SOIC_IC | RI-16-2 |
| ADuM262N1BRIZ | -40°C to +125°C | 4 | 2 | 5.0 | High | 16-Lead SOIC_IC | RI-16-2 |
| ADuM262N1BRIZ-RL | -40°C to +125°C | 4 | 2 | 5.0 | High | 16-Lead SOIC_IC | RI-16-2 |
| ADuM262N1WBRIZ | -40°C to +125°C | 4 | 2 | 5.0 | High | 16-Lead SOIC_IC | RI-16-2 |
| ADuM262N1WBRIZ-RL | -40°C to +125°C | 4 | 2 | 5.0 | High | 16-Lead SOIC_IC | RI-16-2 |
| ADuM262N0BRIZ | -40°C to +125°C | 4 | 2 | 5.0 | Low | 16-Lead SOIC_IC | RI-16-2 |
| ADuM262N0BRIZ-RL | -40°C to +125°C | 4 | 2 | 5.0 | Low | 16-Lead SOIC_IC | RI-16-2 |
| ADuM263N1BRIZ | -40°C to +125°C | 3 | 3 | 5.0 | High | 16-Lead SOIC_IC | RI-16-2 |
| ADuM263N1BRIZ-RL | -40°C to +125°C | 3 | 3 | 5.0 | High | 16-Lead SOIC_IC | RI-16-2 |
| ADuM263N0BRIZ | -40°C to +125°C | 3 | 3 | 5.0 | Low | 16-Lead SOIC_IC | RI-16-2 |
| ADuM263N0BRIZ-RL | -40°C to +125°C | 3 | 3 | 5.0 | Low | 16-Lead SOIC_IC | RI-16-2 |

¹ Z = RoHS Compliant Part.

² W = Qualified for Automotive Applications.

AUTOMOTIVE PRODUCTS

The ADuM262N1WBRIZ and the ADuM262N1BRIZ-RL models are available with controlled manufacturing to support the quality and reliability requirements of automotive applications. Note that these automotive models may have specifications that differ from the commercial models; therefore, designers should review the Specifications section of this data sheet carefully. Only the automotive grade products shown are available for use in automotive applications. Contact your local Analog Devices account representative for specific product ordering information and to obtain the specific Automotive Reliability reports for these models.

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